

Quarterly Reliability Monitoring Results

Quarters: Q1/2021 to Q4/2021

Based on structural similarity

| Supplier | | User Part Number | | | | | | |
|--|--|---|-------------|-----------|------------|-----------|--|---|
| Nexperia B.V. Name of Laboratory Assembly reliability labs Based on AEC-Q101 Test | | PBSS301PD Part Description | | | | | | |
| | | | | | | | | Nexperia DHAM Small Signal Bipolar Transistor |
| | | SMD package | | | | | | |
| | | Test Conditions | Duration | # Lots | # Quantity | # Rejects | | |
| | | | TEST | | | | | |
| | Pre- and Post-Stress | | | | | | | |
| # E1 | Electrical Test | Tamb = 25 °C | N/A | see below | all parts | see below | | |
| | | JESD22-A113 Bake Tamb = 125 °C | 24 hours | | | | | |
| | PC | Soak Tamb = 85 °C, RH = 85% | 168 hours | | | | | |
| # A1 | Preconditioning | Reflow soldering | 3 cycles | 849 | 61170 | 0 | | |
| | | MIL-STD-750-1 | | | | | | |
| | HTRB | M1039 Method A | | | | | | |
| | | Tj = Tjmax, Vr = 100% of max. datasheet | | | | | | |
| # B1 | Bias | reverse voltage | 1000 hours | 202 | 16160 | 0 | | |
| | тс | JESD22-A104 | | | | | | |
| # A4 | Temperature Cycling | -65 °C to Tjmax, not to exceed 150°C | 1000 cycles | 171 | 13680 | 0 | | |
| | | JESD22-A102 | | | | | | |
| | AC | Tamb = 121 °C, RH = 100 % | | | | | | |
| # A3 alt | Autoclave | Pressure = 205 kPa (29.7 psia) | 96 hours | 173 | 13840 | 0 | | |
| | | 150000 4101 | | | | | | |
| | H3TRB | JESD22-A101 Tamb = 85 °C, RH = 85%, VR = 80 % of | | | | | | |
| 4 A D alt | High Humidity High Temperature Reverse Bias | | 1000 hours | 173 | 13840 | 0 | | |
| # A2 alt | Temperature Reverse blas | | 1000 nours | 175 | 13840 | 0 | | |
| | IOL | MIL-STD-750 Method 1037 ton = toff, devices powered to insure ΔT_j = | | | | | | |
| # A5 | Intermittent Operating Life | | 1000 hours | 197 | 15760 | 0 | | |
| # AJ | | | 1000 110015 | 1.57 | 13700 | v | | |
| | RSH | JESD22-A111 | | | | | | |
| # C8 | Resistance to Solder Heat | 260 °C ± 5 °C | 10 s | 135 | 4050 | 0 | | |
| | SD | | | | | | | |
| # C10 | Solderability | J-STD-002 | | 342 | 3420 | 0 | | |

[1] The maximum applied voltage is limited by test chamber set up and does not exceed 115V.

Calculation of FIT and MTTF

Test considered for FIT calculation: High Temperature Reverse Bias (HTRB, Test #B1) Confidence level 60%, derated to 55 °C, activation energy 0.7 eV, test time 168 to 1000 hours

| Wafer Fab | Technology | Quantity | Rejects | Failure Rate (FIT) | MTTF (hrs) |
|------------------|------------------------------------|----------|---------|--------------------|------------|
| Nexperia DHAM | Small Signal Bipolar Transistor | 16160 | 0 | 0.26 | 3.81E+09 |

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